



Mini-Circuits

CERAMIC

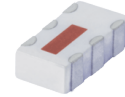
High Pass Filter

HFCN-3800+

50Ω 4250 to 10000 MHz

THE BIG DEAL

- Small size
- 5 sections
- Temperature stable
- Excellent power handling, 7W
- Hermetically sealed
- LTCC construction
- Low cost
- Protected by US Patent 7,760,485



Generic photo used for illustration purposes only

CASE STYLE: FV1206-1

+RoHS Compliant

The +Suffix identifies RoHS Compliance.
See our website for methodologies and qualifications

APPLICATIONS

- Sub-harmonic rejection
- Transmitters/receivers

ELECTRICAL SPECIFICATIONS^{1,2} AT 25°C

Parameter	Frequency (MHz)	Min.	Typ.	Max.	Units
Stop Band	Rejection Loss	2500	—	30	dB
		3200	20	—	
	Freq. Cut-Off	3800	—	3.0	dB
	VSWR	2500-3200	—	20	
Pass Band	Insertion Loss	4250-10000	—	2.0	dB
		4500-9000	—	1.5	
	VSWR	3950-10000	—	1.5	:1

1. In Application where DC voltage is present at either input or output ports, coupling capacitors are required. Alternatively, Mini-Circuits' "D" suffix version of this model will provide >100 MOhm isolation to ground.

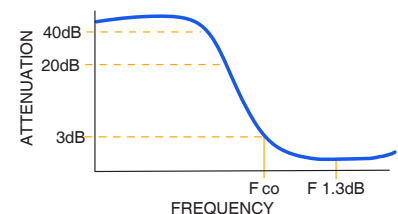
2. Measured on Mini-Circuits Characterization Test Board TB-285.

MAXIMUM RATINGS

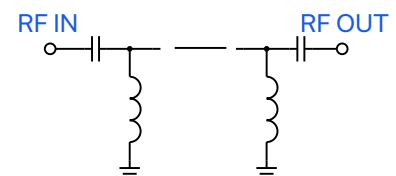
Parameter	Ratings
Operating temperature	-55°C to 100°C
Storage temperature	-55°C to 100°C
RF Power Input ³	7 W max. at 25°C

3. Passband rating, derate linearly to 3W at 100°C ambient.
Permanent damage may occur if any of these limits are exceeded.

TYPICAL FREQUENCY RESPONSE



FUNCTIONAL SCHEMATIC



REV. J
ECO-012367
HFCN-3800+
RAV/CP/AM
230822

Mini-Circuits

www.minicircuits.com P.O. Box 350166, Brooklyn, NY 11235-0003 (718) 934-4500 sales@minicircuits.com

PAGE 1 OF 3



Mini-Circuits®

CERAMIC

High Pass Filter

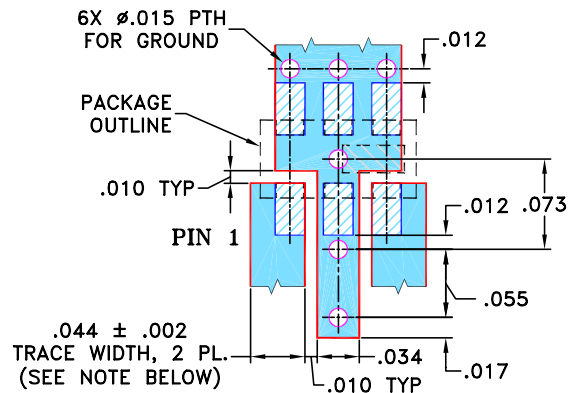
HFCN-3800+

PIN CONNECTIONS

RF IN	1
RF OUT	3
GROUND	2,4,5,6

PRODUCT MARKING: N/A

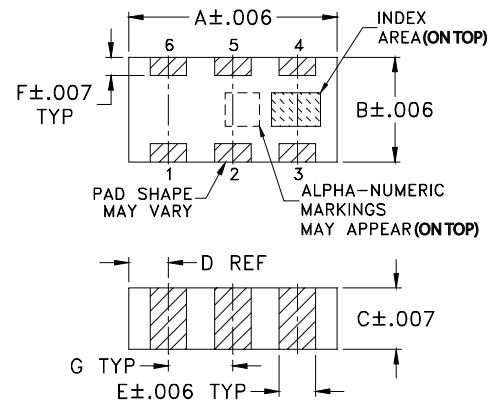
DEMO BOARD MCL P/N: TB-285
SUGGESTED PCB LAYOUT (PL-158)



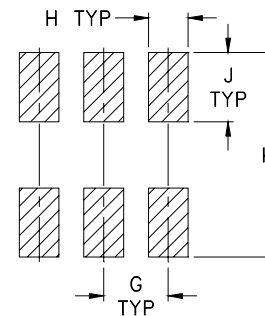
- NOTE:** 1. TRACE WIDTH IS SHOWN FOR ROGERS R04350 WITH DIELECTRIC THICKNESS: $.020 \pm .0015$; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

	DENOTES PCB COPPER LAYOUT
	DENOTES COPPER LAND PATTERN FREE OF SOLDERMASK

OUTLINE DRAWING



PCB Land Pattern



Suggested Layout,
Tolerance to be within $\pm .002$

OUTLINE DIMENSIONS (Inches mm)

A	B	C	D	E	F
.126	.063	.035	.024	.022	.011
3.20	1.60	0.89	0.61	0.56	0.28
G	H	J	K		wt
.039	.024	.042	.123		grams
0.99	0.61	1.07	3.12		.020

TAPE & REEL INFORMATION: F75



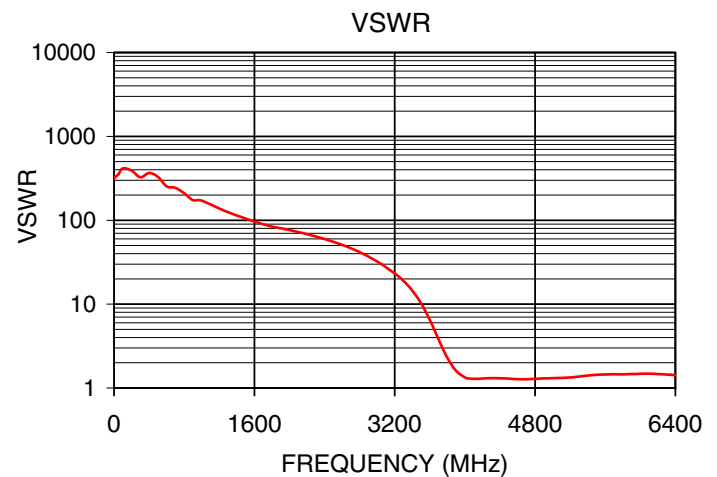
CERAMIC

High Pass Filter

HFCN-3800+

TYPICAL PERFORMANCE DATA AT 25°C

Frequency (MHz)	Insertion Loss (dB)	VSWR (:1)
50.00	55.55	352.78
500.00	36.00	329.74
1500.00	31.71	104.95
3200.00	25.64	23.24
3400.00	25.91	14.49
3500.00	16.74	10.30
3800.00	3.55	2.30
4000.00	1.50	1.34
4250.00	0.97	1.31
4500.00	0.78	1.29
5000.00	0.70	1.31
5500.00	0.66	1.44
6000.00	0.61	1.48
6400.00	0.59	1.42



NOTES

- Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
- The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard. Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp



Ceramic High Pass Filter

HFCN-3800+

Typical Performance Data

FREQUENCY (MHz)	INSERTION LOSS @ +25° C (dB)	INPUT RETURN LOSS @ +25° C (dB)	OUTPUT RETURNLOSS @ +25° C (dB)
40	53.47	0.00	0.00
50	54.77	0.01	0.01
100	51.24	0.00	0.02
200	45.63	0.01	0.01
500	38.20	0.01	0.04
1000	33.57	0.07	0.03
1500	33.33	0.14	0.14
2000	41.16	0.22	0.20
2500	35.39	0.30	0.35
3000	30.82	0.50	0.56
3100	33.87	0.58	0.61
3200	36.48	0.60	0.71
3400	18.78	0.98	1.09
3500	13.18	1.42	1.47
3550	11.01	1.73	1.88
3800	2.99	7.68	8.00
3950	1.52	15.93	17.39
4000	1.29	20.01	23.14
4250	1.03	20.69	21.33
4500	0.96	21.31	21.11
5000	0.81	33.92	27.51
5500	0.83	19.44	19.03
6000	0.88	16.09	15.74
6500	0.89	15.26	14.94
7000	0.83	15.94	15.65
7500	0.74	18.02	17.73
8000	0.64	21.50	22.44
8500	0.61	23.57	25.79
9000	0.67	19.17	18.72
9500	0.89	14.88	14.03
10000	1.20	11.79	11.27
10500	1.65	9.96	9.20
11000	2.25	9.38	8.15
11330	3.27	10.92	7.43
11500	4.38	16.35	6.89
12000	4.23	17.83	12.86
12500	5.61	7.05	5.14
13000	3.36	8.15	6.61
13500	2.67	15.70	9.92
14000	4.78	8.59	6.82
14500	12.44	2.97	3.68

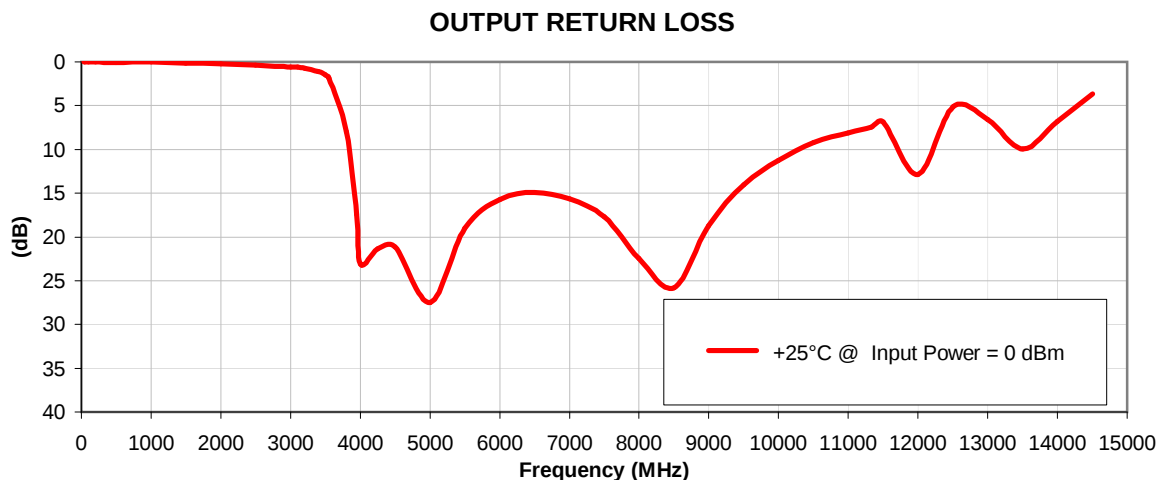
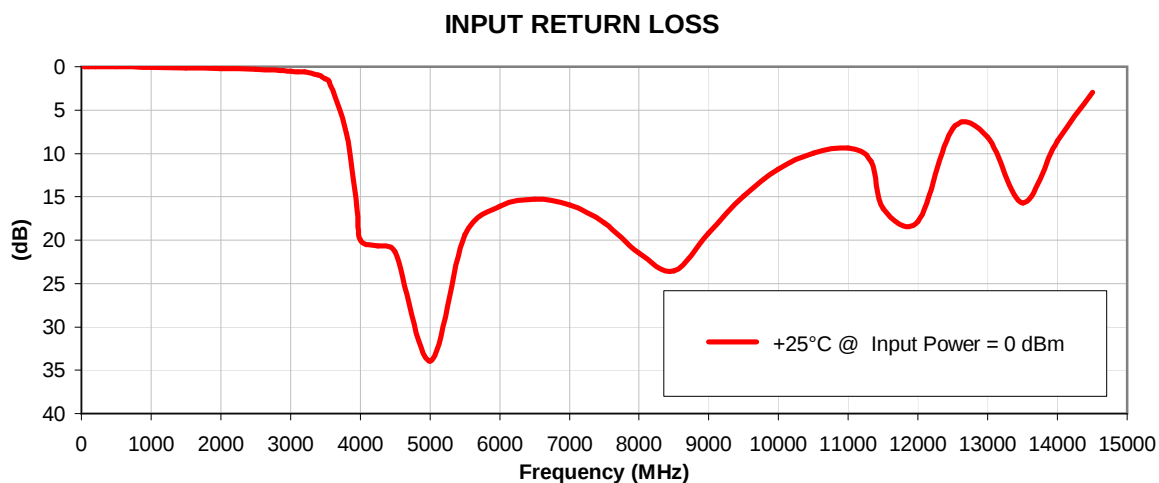
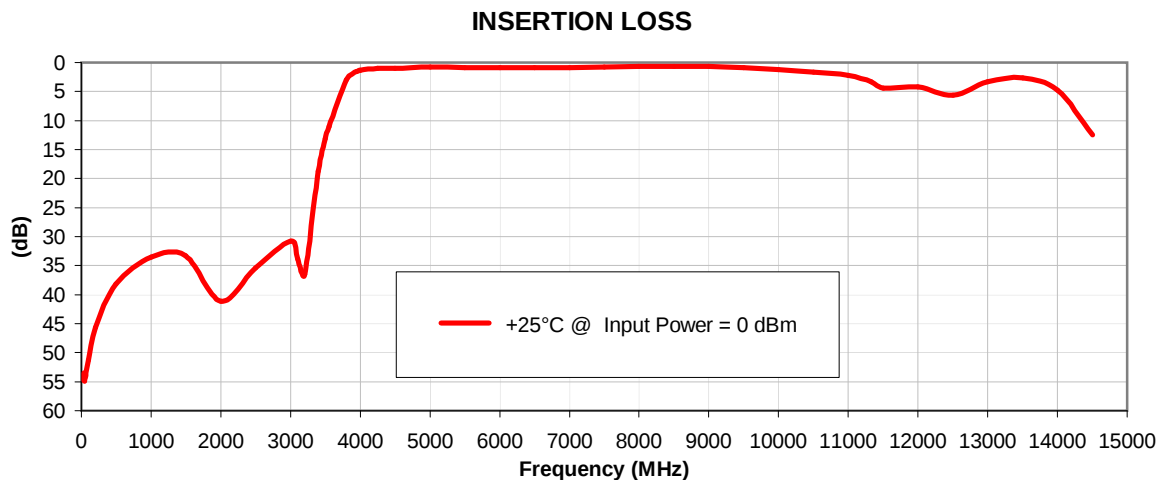
REV. X1
HFCN-3800+
071011
Page 1 of 1



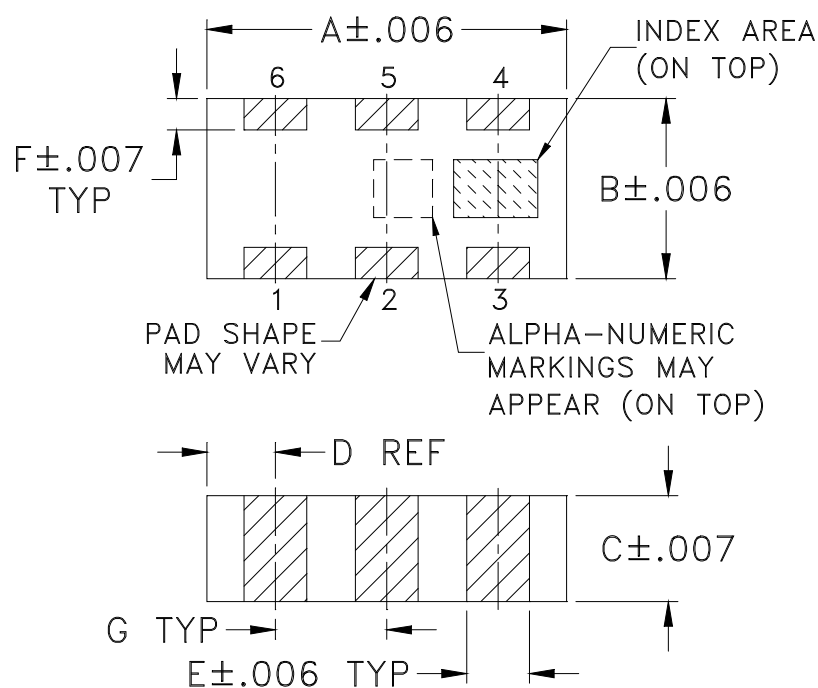
Mini-Circuits®
IF/RF MICROWAVE COMPONENTS • ISO 9001 ISO 14001 AS9100 CERTIFIED • RoHS compliant
P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661
The Design Engineers Search Engine finds the model you need, Instantly • For detailed performance specs & shopping online see



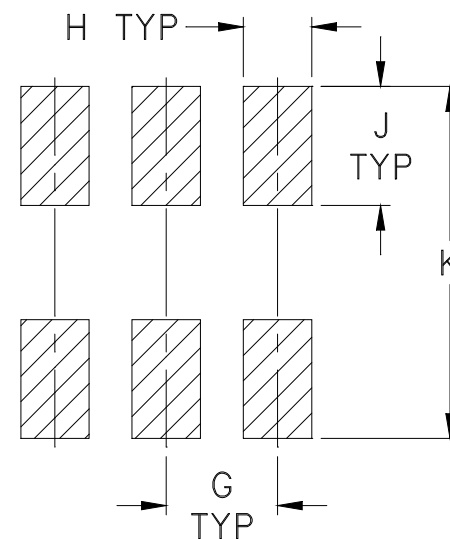
Typical Performance Curves



Outline Dimensions



PCB Land Pattern



Suggested Layout,
Tolerance to be within $\pm .002$

CASE #	A	B	C	D	E	F	G	H	J	K	L	M	N	P	WT. GRAM
FV1206-1	.126 (3.20)	.063 (1.60)	.035 (0.89)	.024 (0.61)	.022 (0.56)	.011 (0.28)	.039 (0.99)	.024 (0.61)	.042 (1.07)	.123 (3.12)	--	--	--	--	.020

Dimensions are in inches (mm). Tolerances: 2 PL. $\pm .01$; 3 PL. $\pm .005$

Notes:

- Open style, ceramic base.
- Termination finish: **as shown below or indicated on Data Sheet.**
 For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.
 For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.



P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site



The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com

RF/IF MICROWAVE COMPONENTS

Tape & Reel Packaging

TR-F75

DEVICE ORIENTATION IN T&R

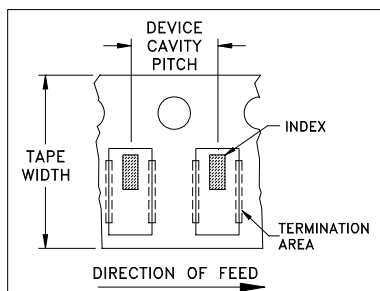


ILLUSTRATION 1

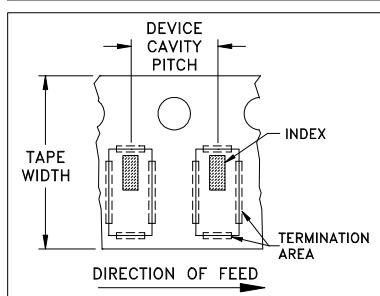


ILLUSTRATION 2

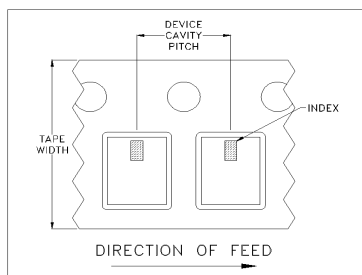


ILLUSTRATION 3

Applicable Case Styles
FV1206-1
FV1206-3

Applicable Case Styles
FV1206-4
FV1206-5
FV1206-6
FV1206-7
FV1206-9
JC0603C-1

Applicable Case Styles
NL1008C-6
FV1206-12
NL1008C-9
NL1008C-10

Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel	
8	4	7	Small quantity standards (see note)	20
				50
				100
				200
				500
				1000
			Standard	3000

Note: Please consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf

Mini-Circuits ISO 9001 & ISO 14001 Certified

Mini-Circuits®

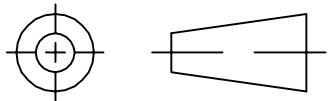
Distribution Centers NORTH AMERICA 800-654-7949 • 417-335-5935 • Fax 417-335-5945 • EUROPE 44-1252-832600 • Fax 44-1252-837010

Mini-Circuits ISO 9001 & ISO 14001 Certified

INTERNET <http://www.minicircuits.com>

P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661

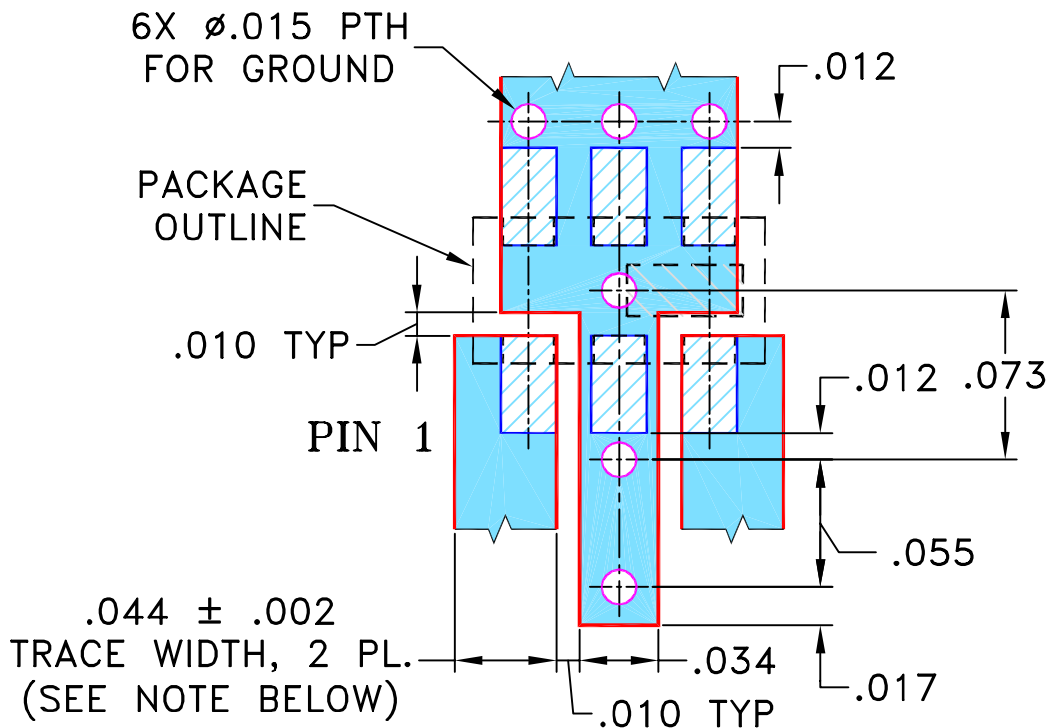
THIRD ANGLE PROJECTION



REVISIONS

REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M92199	NEW RELEASE	05/24/04	AV	ABD
A	M99247	ADD GROUND PTH	06/05	RZ	RZ
A	R60782	ADD GROUND PTH	06/05	RZ	RZ
B	M102713	ADDED "...WITH SMOBC"	01/12/06	GF	IL

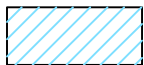
SUGGESTED MOUNTING CONFIGURATION
FOR FV1206-1 CASE STYLE, "pr" PIN CONNECTION.



- NOTE: 1. TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .020" ± .0015". COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.



DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)



DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED

INITIALS

DATE

DIMENSIONS ARE IN INCHES

TOLERANCES ON:

2 PL DECIMALS ±

3 PL DECIMALS ± .005

ANGLES ±

FRACTIONS ±

DRAWN

AV

05/03/04

CHECKED

IL

05/24/04

APPROVED

ABD

05/24/04

Mini-Circuits®

THIS DOCUMENT AND ITS CONTENTS ARE THE PROPERTY OF MINI-CIRCUITS. EXCEPT FOR USE EXPRESSLY GRANTED, IN WRITING, TO ITS VENDORS, VENDEE AND THE UNITED STATES GOVERNMENT, MINI-CIRCUITS RESERVES ALL PROPRIETARY DESIGN, USE, MANUFACTURING AND REPRODUCTION RIGHTS THERETO. THESE CONTENTS SHALL NOT BE USED, DUPLICATED OR DISCLOSED TO ANY OUTSIDE PARTY, IN WHOLE OR IN PART, WITHOUT WRITTEN PERMISSION OF MINI-CIRCUITS.

ASHEETA1.DWG REV:A DATE:01/12/95



Mini-Circuits®

13 Neptune Avenue
Brooklyn NY 11235

PL, pr, FV1206-1, HFCN, TB-285

SIZE

A

CODE IDENT

15542

DRAWING NO:

98-PL-158

REV:

B

FILE:

98PL158

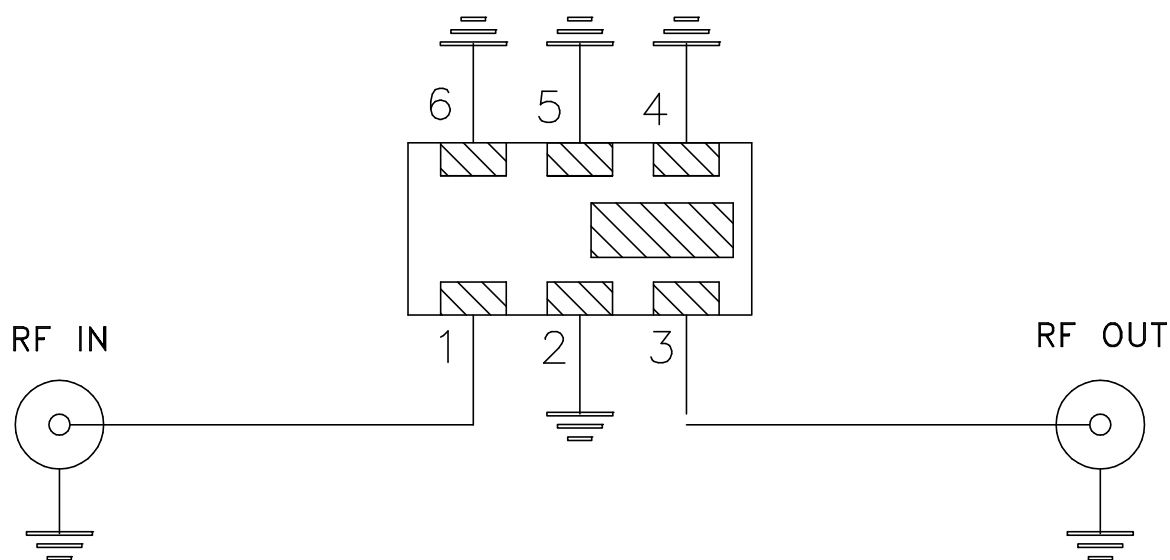
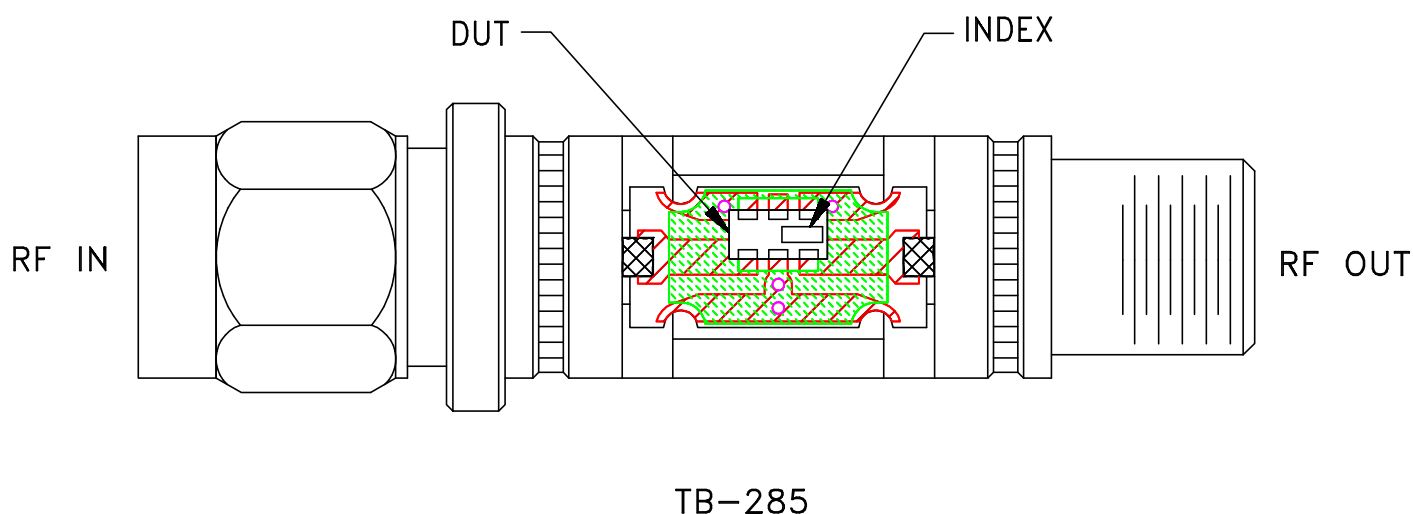
SCALE:

12:1

SHEET:

1 OF 1

Evaluation Board and Circuit



Schematic Diagram

Notes:

1. SMA Female connectors.
2. PCB Material: Rogers R04350 or equivalent,
Dielectric Constant=3.5, Thickness=.020 inch.

 **Mini-Circuits®**



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-55° to 100°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, Para 4.2.5, Test S, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A